APPROVAL SHEET

MR12, MR10, MR08, MR06, MR04

±1%, ±5%

Thick film General Purpose Chip Resistors
Size 1206, 1210, 0805, 0603, 0402
Automotive & Military Compliant

*Contents in this sheet are subject to change without prior notice.

FEATURE

1. High reliability and stability ±1%
2. Sulfuration resistant
3. Automotive AEC Q-200 & Military MIL-STD Compliant
4. 100% CCD inspection
5. RoHS 2 compliant and Halogen free products

APPLICATION

- Automotive application
- Consumer electrical equipment
- EDP, Computer application
- Telecom application

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

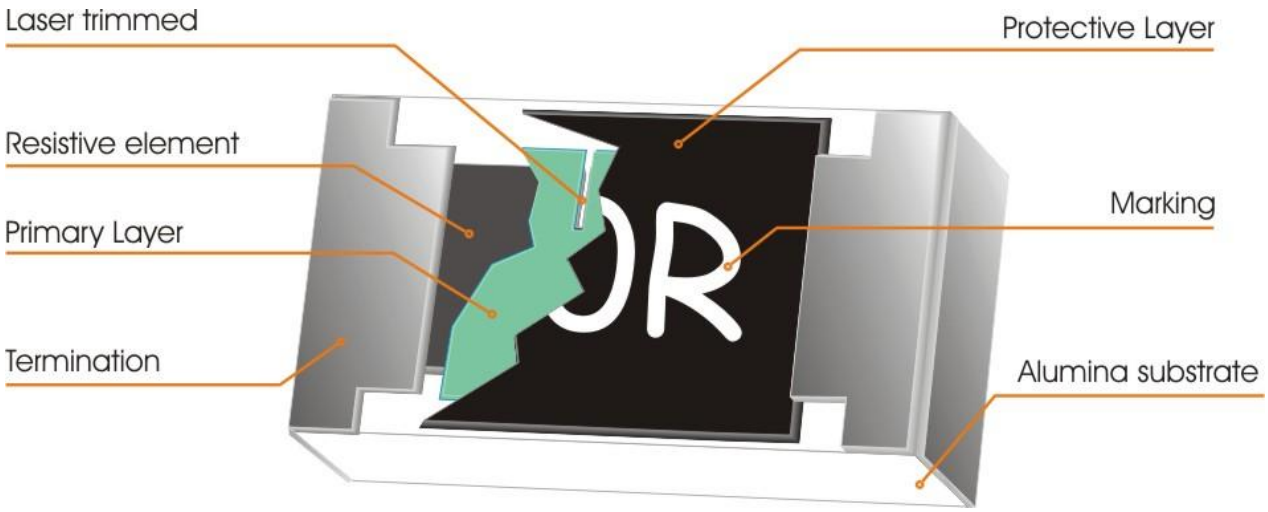


Fig 1. Construction of a Chip-R

QUICK REFERENCE DATA

Item	General Specification									
Series No.	MR10		MR12		MR08		MR06		MR04	
Size code	1210(3225)		1206(3216)		0805(2012)		0603(1608)		0402(1005)	
Resistance Range	1Ω~10MΩ (±5% tolerance), Jumper 1Ω~10MΩ (±1% tolerance)									
Resistance Tolerance	±1% E96/E24	±5% E24	±1% E96/E24	±5% E24	±1% E96/E24	±5% E24	±1% E96/E24	±5% E24	±1% E96/E24	±5% E24
TCR (ppm/°C) R > 1MΩ 10Ω < R ≦ 1MΩ R ≦ 10Ω	≤ ± 200 ≤ ± 100 -200~+400		≤ ± 200 ≤ ± 100 -200~+400		≤ ± 200 ≤ ± 100 -200~+400		≤ ± 200 ≤ ± 100 -200~+400		≤ ± 200 ≤ ± 100 -200~+400	
Max. dissipation @ T_{amb}=70°C	1/2 W		1/4 W		1/4 W		1/8 W		1/10 W	
Max. Operation Voltage (DC or RMS)	200V		200V		150V		75V		50V	
Max. Overload Voltage (DC or RMS)	400V		400V		300V		150V		100V	
Climatic category (IEC 60068)	55/155/56									

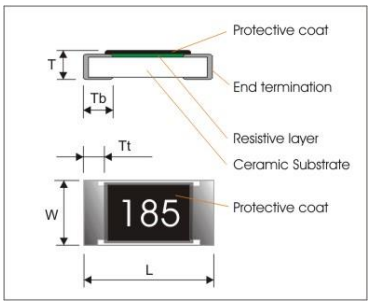
Note :

1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8”
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

   $RCWV = \sqrt{Rated\,Power \times Resistance\,Value}$ or Max. RCWV listed above, whichever is lower.
3. The resistance of Jumper is defined <0.05Ω.

DIMENSIONS (unit : mm)

	MR10	MR12	MR08	MR06	MR04
L	3.10 ± 0.10	3.10 ± 0.10	2.00 ± 0.10	1.60 ± 0.10	1.00 ± 0.05
W	2.60 ± 0.10	1.60 ± 0.10	1.25 ± 0.10	0.80 ± 0.10	0.50 ± 0.05
T	0.55 ± 0.10	0.60 ± 0.15	0.50 ± 0.15	0.45 ± 0.15	0.35 ± 0.05
Tb	0.50 ± 0.20	0.45 ± 0.20	0.40 ± 0.20	0.30 ± 0.15	0.25 ± 0.10
Tt	0.50 ± 0.20	0.50 ± 0.20	0.40 ± 0.20	0.30 ± 0.10	0.20 ± 0.10



MARKING

Size \ Nr. Of digit of code\tolerance	±5%	±1%
1210/1206/0805	3-digits marking	4-digits marking
0603 (1608)	3-digits marking	3-digits marking
0402(1005)	N0 MARKING	

3-digits marking（±5% : 1206, 1210, 0805 & 0603 ）

Each resistor is marked with a three digits code on the protective coating to designate the nominal resistance value.

3-digits marking（±1% : 0603）

Nominal resistance	Description
1.E-24 series	As *0603 WR06X* ±5%.
2.E-96 series	The 1st two digit codes are referring to the CODE on the table, the 3rd code is the index of resistance value : $Y=10^{-2}$，$X=10^{-1}$，$A=10^{0}$，$B=10^{1}$，$C=10^{2}$，$D=10^{3}$，$E=10^{4}$，$F=10^{5}$ EX : 17.8Ω=25X，178Ω=25A，1K78 =25B 17K8=25C， 178K=25D， 1M78=25E
3. Remark	There is no marking for the items are not under E-24 and E-96 series

CODE	R_value	CODE	R_value	CODE	R_Value	CODE	R_value	CODE	R_value	CODE	R_value	CODE	R_value	CODE	R_value
01	**100**	13	**133**	25	**178**	37	**237**	49	**316**	61	**422**	73	**562**	85	**750**
02	**102**	14	**137**	26	**182**	38	**243**	50	**324**	62	**432**	74	**576**	86	**768**
03	**105**	15	**140**	27	**187**	39	**249**	51	**332**	63	**442**	75	**590**	87	**787**
04	**107**	16	**143**	28	**191**	40	**255**	52	**340**	64	**453**	76	**604**	88	**806**
05	**110**	17	**147**	29	**196**	41	**261**	53	**348**	65	**464**	77	**619**	89	**825**
06	**113**	18	**150**	30	**200**	42	**267**	54	**357**	66	**475**	78	**634**	90	**845**
07	**115**	19	**154**	31	**205**	43	**274**	55	**365**	67	**487**	79	**649**	91	**866**
08	**118**	20	**158**	32	**210**	44	**280**	56	**374**	68	**499**	80	**665**	92	**887**
09	**121**	21	**162**	33	**215**	45	**287**	57	**383**	69	**511**	81	**681**	93	**909**
10	**124**	22	**165**	34	**221**	46	**294**	58	**392**	70	**523**	82	**698**	94	**931**
11	**127**	23	**169**	35	**226**	47	**301**	59	**402**	71	**536**	83	**715**	95	**953**
12	**130**	24	**174**	36	**232**	48	**309**	60	**412**	72	**549**	84	**732**	96	**976**

4-digits marking（±1% : 1210/1206/0805）

Each resistor is marked with a four digits code on the protective coating to designate the nominal resistance value.

Example

RESISTANCE	10Ω	12Ω	100Ω	6800Ω	47000Ω
3-digits marking（1210, 1206, 0805, 0603 ±5% ）	100	120	101	682	473
4-digits marking	10R0	12R0	1000	6801	4702

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of ±5%, and E24+E96 series for resistors with a tolerance of ±1%. The values of the E24/E96 series are in accordance with “IEC publication 60063”.

Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2.1

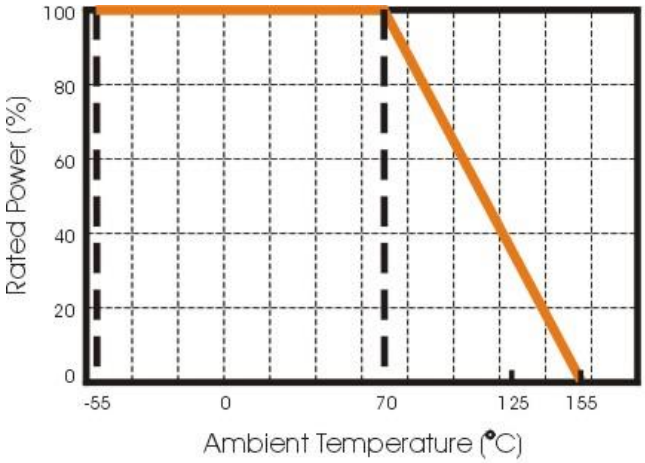


Figure 2.1 Maximum dissipation in percentage of rated power as a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

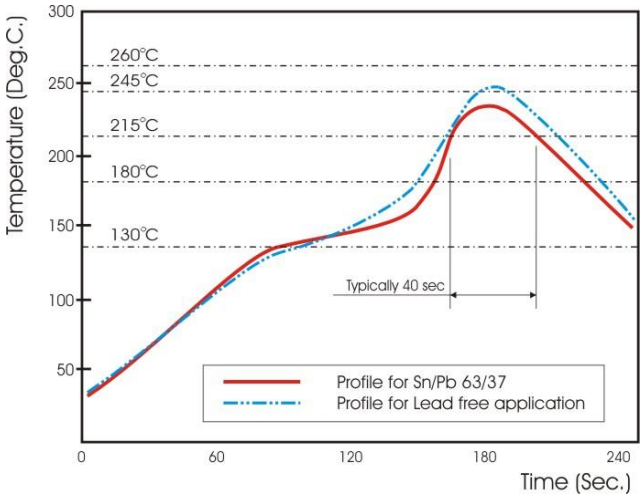
Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.



of

Fig 3. Infrared soldering profile for Chip Resistors

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

MR12	X	472_	J	T	L
Automotive code MR10 : 1210 MR12 : 1206 MR08 : 0805 MR06 : 0603 MR04: 0402	**Type code** **X :** ±5%, 1Ω ~ 10MΩ ±1%, 10Ω ~ 1MΩ **W** : ±1%, < 10Ω; >1MΩ	**Resistance code** **±5%,** E24: 2 significant digits followed by no. of zeros and a blank 220Ω = 221_ 4K7 = 472_ 10Ω = 100_ 1Ω =1R0_ ("_" means a blank) **Resistance code** **±1%,** E24+E96: 3 significant digits followed by no. of zeros E96: 37.4KΩ = 3742 E24: 220Ω = 2200 4K7 = 4701 10Ω = 10R0 1Ω =1R00	**Tolerance** F : ±1% J : ±5% P : Jumper	**Packaging code** T : 7" Reeled taping D : 7" Reel 20K/RL 0402 size Q : 10" Reeled taping G : 13" Reeled taping B : Bulk	**Termination code** L = Sn base (lead free)

* Anti-Sulfuration test conditions: H2S 3ppm, 40'C, RH 90%, 1000hrs, criteria: +/-1% !

MR10, MR12,MR08,MR06:

1. Reeled tape packaging : 8mm width paper taping 5000pcs per 7" reel, 10kpcs per 10" reel, 20kpcs per 13" reel.
2. Bulk packaging : 5000pcs per poly-bag

MR04:

1. Reeled tape packaging : 8mm width paper taping 10,000pcs per reel,
2. Bulk packaging : 10,000pcs per poly-bag

TEST AND REQUIREMENTS

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category **LCT**/**UCT**/56(rated temperature range : **L**ower **C**ategory **T**emperature, **U**pper **C**ategory **T**emperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, sub-clause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with midly activated flux.

TEST	PROCEDURE / TEST METHOD	REQUIREMENTS	
		Resistance	**0Ω**
Electrical Characteristics **JISC5201-1: 1998** Clause 4.8	- DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6$ (ppm/°C) t_1 : 20°C+5°C-1°C R_1 : Resistance at reference temperature R_2 : Resistance at test temperature	Within the specified tolerance Refer to “QUICK REFERENCE DATA”	
Resistance to soldering heat (R.S.H) **MIL-STD-202 method 210**	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 270℃±5°C	ΔR/R max. ±(0.5%+0.05Ω) No visible damage	<50mΩ
Solderability **J-STD-002**	a) Bake the sample for 155℃ dwell time 4hrs/ solder dipping 235℃/ 5sec. b) Steam the sample dwell time 1 hour/ solder dipping 260℃/ 7sec.	95% coverage min., good tinning and no visible damage	
Temperature cycling **JESD22 method JA-104**	1000 cycles, -55℃ ~ +155℃, dwell time 5~10min	ΔR/R max. ±(0.5%+0.05Ω) No visible damage	<50mΩ
Moisture Resistance **MIL-STD-202 method 106**	65±2°C, 80~100% RH, 10 cycles, 24 hours/ cycle	ΔR/R max. ±(0.5%+0.05Ω) No visible damage	<50mΩ
Bias Humidity **MIL-STD-202 method 103**	1000+48/-0 hours; 85°C, 85% RH, 10% of operation power	ΔR/R max. ±(1%+0.05Ω) No visible damage	<50mΩ
Operational Life **MIL-STD-202 method 108**	1000+48/-0 hours; 35% of operation power, 125±2°C	ΔR/R max. ±(1%+0.05Ω) No visible damage	<50mΩ

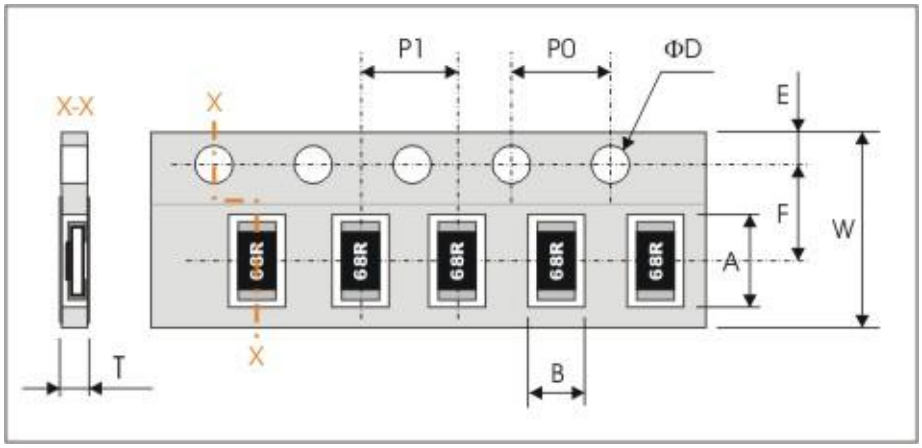
TEST	PROCEDURE / TEST METHOD	REQUIREMENTS	
		Resistance ±5%, ±1%	0Ω
High Temperature Exposure **MIL-STD-202 method 108**	1000+48/-0 hours; without load in a temperature chamber controlled 155±3°C	ΔR/R max. ±(1%+0.05Ω) No visible damage	<50mΩ
Mechanical Shock **MIL-STD-202 method 213**	1/2 Sine Pulse / 1500g Peak / Velocity 15.4ft/sec	Within the specified tolerance No visible damage	<50mΩ
Board Flex **AEC-Q200-005**	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 2mm for 10sec	ΔR/R max. ±(1.0%+0.05Ω). No visible damage	<50mΩ
Terminal strength **AEC-Q200-006**	Pressurizing force: 1Kg, Test time: 60±1sec.	No remarkable damage or removal of the terminations	
Vibration **MIL-STD-202 method 204**	Test 5g's for 20min., 12 cycles each of 3 orientations	ΔR/R max. ±(1.0%+0.05Ω) No visible damage	<50mΩ
Thermal shock **MIL-STD-202 method 107**	Test –55 to 155℃/ dwell time 15min/ Max transfer time 20sec 300cycles	ΔR/R max. ±(0.5%+0.05Ω) No visible damage	<50mΩ
ESD **AEC-Q200-002**	Test contact 1.0KV (0.5KV for 0402 only)	ΔR/R max. ±(1%+0.05Ω) No visible damage	<50mΩ

TEST CONDITION FOR JUMPER (0 Ω)

Item	MR10	MR12	MR08	MR06	MR04
Power Rating At 70°C	1/2W	1/4W	1/4W	1/8W	1/10W
Resistance	MAX.50mΩ				
Rated Current	3A	2A	2A	1.5A	1A
Peak Current	7.5A	5A	5A	3.5A	3A
Operating Temperature	-55 ~ +155°C				

PACKAGING

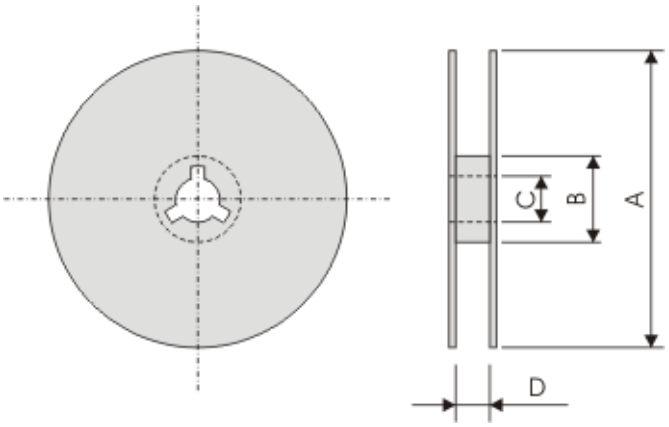
Paper Tape specifications (unit :mm)



Series No.	A	B	W	F	E
MR10	3.60±0.20	3.00±0.20	8.00±0.30	3.50±0.20	1.75±0.10
MR12	3.60±0.20	2.00±0.20			
MR08	2.40±0.20	1.65±0.20			
MR06	1.90±0.20	1.10±0.20			
MR04	1.20±0.10	0.70±0.10			

Series No.	P1	P0	ΦD	T
MR10/12/08	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	Max. 1.0
MR06				0.65±0.05
MR04	2.00±0.10			0.40±0.05

7” Reel dimensions



Symbol	A	B	C	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Thick Film Resistors ***category:***

Click to view products by Walsin ***manufacturer:***

Other Similar products are found below :

MCR03EZPFX3162 MCR004YZPJ332 201007J022KT4E 201007F1653T4E 201007F6652T4E 0603WAF137KT5E RTT204702FTE RTT203000FTE RTT2056R0FTE CR2010F470KE04Z RTT018451FTH RTT021802DTH 0402WGF510LTCE 0201WMJ0200TEE TR0603B26K7P0550Z 0201WMF5102TEE 1210W2J047KT5E YLR12-2-4F-W HOT(0.25x1.3)-3.2-0R-I HOT(0.4x1.5)-5.2-0R-I HoT(0.45x1.5)-8.2-0R-I 0201WMF1103TEE 0201WMF7152TEE 1210W2J0124T5E 201007J010LT4E 201007J0360T4E 201007J0430T4E 0805W8F931KT5E 1206W4F5231T5E 1210W2J0620T5E 201007J0822T4E 0201WMF1005TCE 0201WMF1212TCE 0201WMF1373TCE 0201WMF1400TCE 0201WMF2000TEE 0201WMF2001TCE 0201WMF226JTCE 0201WMF2672TCE 0201WMF2803TCE 0201WMF357JTCE 0201WMF3743TCE 0201WMF430JTCE 0201WMF4990TCE 0201WMF5104TCE 0201WMF510JTEE 0201WMF5110TCE 0201WMF6652TEE 0201WMF6812TCE 0201WMF8200TCE